# Panasonic industry 

## AH1 (FJ) Switches

## Ultra-miniature Size Switches High Precision



FEATURES

- Compact size, light weight and high precision
- Switches that can be used with M2 general-purpose screws
- Integrally molded terminals that discourage inflow of solder flux provide and also switch body has standoff
- Lineup also includes AgNi alloy + Au-clad contact types optimized for low-voltage current loading - Self-standing terminal easily mounted on P/C boards
- Protection grade: IP40


## TYPICAL APPLICATIONS

- Electric pot
- Automobiles (Detection of key position), etc.

ORDERING INFORMATION (PART NO.)


## PRODUCT TYPES TABLE

■ Mounting hole M2 mm type (with stand off)

| Contact specification | Applicable current range |  |  |  |  | Operating Force OF (max.) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1 mA | 0.1 A | 1 A | 3 A |  | 0.74 N | 1.47 N |
| AgNi alloy contact type |  |  |  |  |  | Available |  |
|  |  |  |  |  |  |  | Available |
| AgNi alloy + <br> Au-clad contact type |  |  |  |  |  | Available |  |
|  |  |  |  |  |  |  | Available |

## TYPES

$\square$ Self-standing P/C board terminal

| Actuators | Operating Force <br> (OF) Max. | AgNi alloy contact type | AgNi alloy + Au-clad contact type |
| :--- | :---: | :---: | :---: |
| Pin plunger | 0.74 N | AH 1480 | AH 148061 |
|  | 1.47 N | AH 1460 | AH 146061 |
| Hinge lever | 0.25 N | AH 1482 | AH 148261 |
|  | 0.49 N | AH 1462 | AH 146261 |
|  | 0.26 N | AH 1484 | AH 148461 |

Note: Color of plunger
AgNi alloy contact type: white
AgNi alloy + Au-clad contact type: dark red
■Straight P/C board terminal

| Actuators | Operating Force <br> (OF) Max. | AgNi alloy contact type | AgNi alloy + Au-clad contact type |
| :--- | :---: | :---: | :---: |
| Pin plunger | 0.74 N | AH1580 | AH158061 |
|  | 1.47 N | AH1560 | AH156061 |
| Hinge lever | 0.25 N | AH1582 | AH158261 |
|  | 0.49 N | AH1562 | AH156261 |
|  | 0.26 N | AH1584 | AH158461 |
|  | 0.54 N | AH1564 | AH156461 |

Note: Color of plunger
AgNi alloy contact type: white
AgNi alloy + Au-clad contact type: dark red
Solder terminal

| Actuators | Operating Force <br> (OF) Max. | AgNi alloy contact type | AgNi alloy + Au-clad contact type |
| :--- | :---: | :---: | :---: |
| Pin plunger | 0.74 N | AH1680 | AH168061 |
|  | 1.47 N | AH1660 | AH166061 |
| Hinge lever | 0.25 N | AH1682 | AH168261 |
|  | 0.49 N | AH1662 | AH166261 |
|  | 0.26 N | AH1684 | AH168461 |
|  | 0.54 N | AH1664 | AH166461 |

Note: Color of plunger
AgNi alloy contact type: white
AgNi alloy + Au-clad contact type: dark red

P/C board right angle terminal

| Actuators | Operating Force <br> (OF) Max. | AgNi alloy contact type | AgNi alloy + Au-clad contact type |
| :--- | :---: | :---: | :---: |
| Pin plunger | 0.74 N | AH1780 | AH178061 |
|  | 1.47 N | AH1760 | AH176061 |
| Hinge lever | 0.25 N | AH1782 | AH178261 |
|  | 0.49 N | AH1762 | AH176261 |
|  | 0.26 N | AH1784 | AH178461 |
|  | 0.54 N | AH1764 | AH176461 |

Note: Color of plunger
AgNi alloy contact type: white
AgNi alloy + Au-clad contact type: dark red
$\square$ P/C board left angle terminal

| Actuators | Operating Force <br> (OF) Max. | AgNi alloy contact type | AgNi alloy + Au-clad contact type |
| :--- | :---: | :---: | :---: |
| Pin plunger | 0.74 N | AH 1880 | AH188061 |
|  | 1.47 N | AH 1860 | AH186061 |
| Simulated roller lever | 0.25 N | AH 1882 | AH 188261 |
|  | 0.49 N | AH 1862 | AH 186261 |

Notes: 1. Color of plunger
AgNi alloy contact type: white
AgNi alloy + Au-clad contact type: dark red
2. Please order addition 9 at the end of the part number for UL/C-UL products with safety standards.
3. Since the right angle and left angle are as shown in the photo below with the push plunger as the reference point, be careful not to make a mistake.

Left angle

## RATING

## Contact rating

|  |  | Standard rating | Minimum applicable load |
| :---: | :---: | :---: | :---: |
| AgNi alloy contact type | (OF) 0.74 N type | 1 A 125 V AC, 1 A 30 V DC | - |
|  | (OF) 1.47 N type | 3 A 125 V AC, 2 A 30 V DC | - |
| AgNi alloy + Au-clad contact type |  | 0.1 A 125 V AC, 0.1 A 30 V DC | 5 mA 6 V DC, 2 mA 12 V DC, 1 mA 24 V DC |

Note) OF: Value of pin plunger

## $\square$ Specifications

| Item |  | AgNi alloy contact type | AgNi alloy + Au-clad contact type |
| :---: | :---: | :---: | :---: |
| Expected life | Mechanical life (OT) Specified value | (OF) 0.74 N type: Min. $10^{6}$ (at 60 cpm ) (OF) 1.47 N type: Min. $5 \times 10^{5}$ (at 60 cpm ) |  |
|  | Electrical (OT) Max. | Min. $3 \times 10^{4}$ (at 20 cpm ) (at rated load) | Min. $10^{5}$ <br> (at 20 cpm ) (at rated load) |
| Insulation resistance |  | Min. $100 \mathrm{M} \Omega$ (at 500 V DC) |  |
| Dielectric strength | Between non-continuous terminals | 600 Vrms for 1 min |  |
|  | Between each terminal and other exposed metal parts | 1,500 Vrms for 1 min |  |
|  | Between each terminal and ground | 1,500 Vrms for 1 min |  |
| Contact resistance (Initial) |  | $\text { Max. } 30 \mathrm{~m} \Omega$ <br> (by voltage drop, 1 A 6 to 8 V DC) | Max. $100 \mathrm{~m} \Omega$ <br> (by voltage drop, 0.1 A 6 to 8 V DC ) |
| Vibration resistance (Pin pluger type) |  | 10 to 55 Hz at single amplitude of 0.75 mm (Contact opening: Max. 1 msec ) |  |
| Shock resistance (Pin plunger type) |  | Min. $294 \mathrm{~m} / \mathrm{s}^{2}$ (Contact opening: Max. 1 msec ) |  |
| Allowable operating speed (No load) |  | 1 to $500 \mathrm{~mm} / \mathrm{sec}$ |  |
| Max. operating cycle rate (No load) |  | 120 cpm |  |
| Ambient temperature |  | -25 to $+85^{\circ} \mathrm{C}$ (no freezing and condensing) |  |
| Unit weight |  | Approx. 0.5 g |  |
| Protection grade |  | IP40 |  |

Notes: 1. Test conditions and judgement are in accordance with NECA C 4505.
2. OF: Value of pin plunger type

## Operating characteristics

1) Pin plunger

| 3th digit of <br> Part No. | Operating Force <br> (OF) Max. | Release Force <br> (RF) Min. | Pretravel <br> (PT) Max. | Movement <br> Differential <br> (MD) Max. | Overtravel <br> (OT) Min. | Operating Position <br> (OP) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 6 | 1.47 N | 0.20 N |  |  |  | $7 \pm 0.3 \mathrm{~mm}$ <br> (Distance from stand-off) <br> $5.5 \pm 0.2 \mathrm{~mm}$ |
| 8 | 0.74 N | 0.098 N |  | 0.5 mm | 0.12 mm | 0.25 mm |
| (Distance from mounting hole) |  |  |  |  |  |  |

2) Hinge lever

| 3th digit of <br> Part No. | Operating Force <br> (OF) Max. | Release Force <br> (RF) Min. | Pretravel <br> (PT) Max. | Movement <br> Differential <br> (MD) Max. | Overtravel <br> (OT) Min. | Operating Position <br> (OP) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 6 | 0.49 N | 0.049 N |  |  |  | $8.3 \pm 1.2 \mathrm{~mm}$ <br> (Distance from stand-off) <br> $6.8 \pm 1.0 \mathrm{~mm}$ <br> (Distance from mounting hole) |
|  |  |  |  |  | 0.55 mm | $8.3 \pm 1.2 \mathrm{~mm}$ <br> (Distance from stand-off) <br> $6.8 \pm 1.0 \mathrm{~mm}$ |
| 8 | 0.25 N | 0.025 N |  |  |  |  <br> (Distance from mounting hole) |

3) Simulated roller lever

| 3th digit of <br> Part No. | Operating Force <br> (OF) Max. | Release Force <br> (RF) Min. | Pretravel <br> (PT) Max. | Movement <br> Differential <br> (MD) Max. | Overtravel <br> (OT) Min. | Operating Position <br> (OP) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 6 | 0.54 N | 0.039 N |  |  |  | $11.0 \pm 1.2 \mathrm{~mm}$ <br> (Distance from stand-off) <br> $9.5 \pm 1.0 \mathrm{~mm}$ <br> (Distance from mounting hole) |
| 8 | 0.26 N | 0.020 N |  | 0.1 mm | 0.5 mm | 0.5 mm |
| $11.0 \pm 1.2 \mathrm{~mm}$ <br> (Distance from stand-off) <br> $9.5 \pm 1.0 \mathrm{~mm}$ |  |  |  |  |  |  |
| (Distance from mounting hole) |  |  |  |  |  |  |

## DATA

Range of low-level current and voltage (AgNi alloy + Au-clad contact type) (reference)


Combination with Operating Force (OF) and applicable current range (reference)


Note: The diagram above is intended as a reference. Please use the product within the rated voltage and current.

## CONTACT FORM



## ■P/C board terminal

## CAD

- Pin plunger

External dimensions


P/C board pattern


| Pretravel (PT) Max. | 0.5 mm |  |
| :--- | :--- | :---: |
| Movement Differential (MD) Max. | 0.12 mm |  |
| Overtravel (OT) Min. | 0.25 mm |  |
| Operating <br> Position (OP) | Distance from <br> mounting hole | $5.5 \pm 0.2 \mathrm{~mm}$ |
|  | Distance from <br> stand-off | $7 \pm 0.3 \mathrm{~mm}$ |

## - Hinge lever



## External dimensions



P/C board pattern


| Pretravel (PT) Max. | 2.1 mm |  |
| :--- | :--- | :---: |
| Movement Differential (MD) Max. | 0.5 mm |  |
| Overtravel (OT) Min. | 0.55 mm |  |
| Operating <br> Position (OP) | Distance from <br> mounting hole | $6.8 \pm 1.0 \mathrm{~mm}$ |
|  | Distance from <br> stand-off | $8.3 \pm 1.2 \mathrm{~mm}$ |

## Simulated roller lever

External dimensions



P/C board pattern


| Pretravel (PT) Max. | 2.1 mm |  |
| :--- | :--- | :---: |
| Movement Differential (MD) Max. | 0.5 mm |  |
| Overtravel (OT) Min. | 0.5 mm |  |
| Operating <br> Position (OP) | Distance from <br> mounting hole | $9.5 \pm 1.0 \mathrm{~mm}$ |
|  | Distance from <br> stand-off | $11.0 \pm 1.2 \mathrm{~mm}$ |

■Solder terminal
CAD External dimensions


General tolerance: $\pm 0.25$
Note) Dimensions other that drawn above is same as self-standing P/C board terminal.

P/C board right/left angle terminal

## CAD

External dimensions


P/C board pattern



Note) As for other actuator types, dimensions are the same as those of corresponding self-standing P/C board terminal.

## GUIDELINES FOR USAGE

## Fastening of the switch body

1) Use M2 screws to attach switches with Max. $0.098 \mathrm{~N} \cdot \mathrm{~m}$ torque. Also, we recommend the use of spring washers in order to prevent loosening of the installation screws.
2) When the operation object is in the free position, force should not be applied directly to the actuator or to the pin plunger. Also force should be applied to the pin plunger from vertical direction to the switch.
3) In setting the movement after operation, the overtravel "OT"should be set from $70 \%$ to $100 \%$. Setting the movement less than $70 \%$ may cause degrading of the electrical mechanical performance.

## ■Selection of switch

Please make your selection so that there will be no problems even if the operating characteristics vary up to $\pm 20 \%$ from the standard values.

## Soldering operation

Perform soldering in less than 3 seconds with maximum $350^{\circ} \mathrm{C}$ iron. Care should be taken not to apply force to the terminals during soldering. We recommend a soldering iron with temperature adjustment in order to prevent poor quality soldering.
Please consult us if you intend to use a soldering iron of 60 W or higher.

When switching low-level current and voltage, AgNi alloy + Au-clad contact type is recommended.

## Environment

Locations where corrosive gases having a bad influence on contacts are present, and locations where there is an excessive amount of siliceous or other abrasive dust should be avoided.

Please refer to "the latest product specifications" when designing your product.
-Requests to customers:
https://industrial.panasonic.com/ac/e/salespolicies/

## Detection Switches

A compact switch equipped with an enclosed micro-gap snapaction contact mechanism that makes a specified motion with a specified force to open/close a circuit, and an actuator outside the enclosure (hereinafter referred to as the switch)

## $\square$ Actuator

A part of the switch that transmits the received external force to an internal spring mechanism to move the movable contact so that the switch can be opened and closed

## ■Actuator stopper

A part of the switch to limit the actuator movement in the switch operation direction

## ■ Rated values

Values indicating the characteristics and performance guarantee standards of the snap-action switches. The rated current and rated voltage, for instance, assume specific conditions (type of load, current, voltage, frequency, etc.).

## $\square$ Mechanical life

The service life when operated at a preset operating frequency without passing electricity through the contacts. (The life test is performed at a switching frequency of 60 times/minute and operating speed of $100 \mathrm{~mm} /$ second at the regular cam.)

## Electrical life

The service life when the rated load is connected to the contact and switching operations are performed. (The life test is performed at a switching frequency of 20 times/minute and operating speed of 100 $\mathrm{mm} / \mathrm{second}$ at the regular cam.)

## Contact form

This refers to the components determining the type of application which make up the electrical input/output circuits in the contact.


## Insulation resistance

Resistance between non-continuous terminals, each terminal and other exposed metal parts and between each terminal and ground.

## Dielectric

Threshold limit value that a high voltage can be applied to a predetermined measuring location for one minute without causing damage to the insulation.

## Contact resistance

This indicates the electrical resistance at the contact part. Generally, this resistance includes the conductor resistance of the spring and terminal portions.

## Vibration resistance

Malfunction vibration ... Vibration range where a closed contact does not open for longer than a specified time due to vibrations during use of the snap-action switches.

## Shock resistance

Shock durability ... Shock range where the mechanical shocks received during snap-action switches transport and installation do not damage the parts or harm the operating characteristics.
Malfunction shock ... Shock range where a closed contact does not open for longer than a specified time due to shocks during use of the snap-action switches.

TECHNICAL TERMINOLOGY

Definition of operating characteristic
The main terminological illustrations and meanings which are used with snapaction switches are as follows.


| Classification | Terminology | Symbol | Unit | Varying display method | Starting current |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Force | Operating Force | OF | N | Max. | The force required to cause contact snap-action. It is expressed terms of force applied to the the actuator. |
|  | Release Force | RF | N | Min. | The force to be applied to the the actuator at the moment contact snaps back from operated position to total travel position. |
|  | Totaltravel Force | TF | N |  | Force applied to an actuator required to move from an operating position to a total travel position |
| Movement | Pretravel | PT | mm, degree | Max. | Distance or agree of the actuator movement from free position to operating position. |
|  | Overtravel | OT | $\begin{aligned} & \text { mm, } \\ & \text { degree } \end{aligned}$ | Min. | The distance or degree which the actuator is permitted to travel after actuation without any damage to the switching mechanism. |
|  | Movement Differential | MD | mm, degree | Max. | The distance or degree from operating position to release position of the actuator. |
|  | Totaltravel | TT | mm, degree |  | The migration length or the move angle from the free position to total travel position of actuator |
| Position | Free Position | FP | mm, degree |  | Position of the actuator when no force is applied to. |
|  | Operating Position | OP | mm, degree | $\pm$ | The position of the actuator when the traveling contacts snaps with the fixed contact. |
|  | Release Position | RP | mm, degree |  | The position of the actuator when the traveling contact snaps back from operating position to its original position. |
|  | Total travel Position | TTP | mm, degree |  | The stopping position of the actuator after total travel. |

$\square$ Actuation Force and Stroke
Adequate stroke setting is the key to high reliability. It is also important that adequate contact force be 'maintained to ensure high reliability. For a normally closed (N.C.) circuit, the driving mechanism should be set so that the actuator is normally in the free position.
For a normally open (N.O.) circuit, the actuator should be pressed to $70 \%$ to $100 \%$ of the specified stroke to absorb possible errors. If the stroke is set too close to the operating point (OP), this may cause unstable contact, and in the worst case may cause actuator damage due to inertia of the drive mechanism. It is advisable that the stroke be adjusted with the mounting plate or driving mechanism.

The figure at right shows a typical example of activation and contact forces varying with stroke.
In the vicinity of the OP and RP, the contact force is diminished, causing chatter and contact bounce immediately before or after reversal. For this reason, use the switch while giving due consideration to this. This also causes the snap action switch to be sensitive to vibration or shock.


Changes in Operating Characteristics
Exercise design care so that malfunctions will not occur if the operating characteristics vary by as much as $20 \%$ from, rated values.
<Example>
In the OF Max. 0.98 N specification for FS snap-action switches,
the allowable Max. is $0.98 \mathrm{~N}(100 \%+20 \%)=1.18 \mathrm{~N}$
In the RF Min. 0.15 N Min. specification
the allowable Min. $0.15 \mathrm{~N}(100 \%-20 \%)=0.12 \mathrm{~N}$

## Mechanical Conditions for Type Selection

Actuator type should be selected according to activation method, activation speed, activation rate, and activation frequency.

1) An extremely slow activation speed may cause unstable contact transfer, possibly resulting in contact failures or contact fusion.
2) An extremely high activation speed may cause damage to contacts or contact response failure.

## Driving Mechanism

Use of a driving mechanism which will cause physical impact to the actuator should be avoided.

> <Example>


## TECHNICAL NOTES ON ELECTRICAL CHARACTERISTICS

1) The snap-action switch is designed for $A C$ operations. While it has small contact gaps and no arc absorber, it may be used for lowcapacity DC operations.
Please refer to the rating of each products
2) For applications with very small switching voltage or current, choose the low-level load type (Au contact).

3) When selecting a contact type of a snap-action switch to be used for low-level load switching, the following should be noted. Silver contacts' surfaces are prone to be oxidized and form a sulfide film. The switch operates with no problems at thebeginning of use. However, as the contact surfaces develop films with time, the film may not be broken by the switching operation, causing a conduction failure. Therefore, please choose the Au contact type for switching a load of 0.1 A or below.
4) Application to Electronic Circuits

- The snap-action switch contacts can sustain bounce or chatter when closed. Bounce or chatter can cause noise or pulse count errors when the snap action switch is used in electronic circuits.
- If contact bounce or chatter poses problems in the vicinity of the

OP and RP, use a suitable absorption network, such as a C/R network.
5) Check the surge current, normal current and surge duration.
6) Contact resistance given in performance specifications is measured with a voltage drop method using 6 to 8 V DC, 1 A (except for low-level load type). Contact resistance across COM and N.C. terminals is measured in the free position, while contact resistance across COM and N.O. terminals is measured in the total travel position.
7) To prevent contact welding failure, be sure to use a serial resistance for each capacitive load.
8) If snap-action switch operation is synchronized with the AC supply phase, this may cause: shortened electrical life, contact fusion failure, contact transfer, or other reliability problems.

## CAUTIONS IN A CIRCUIT

1) Contact protection is recommended when snap-action switches are used in an inductive load circuit.

| Circuit diagram | Cautions for use |
| :---: | :---: |
| Contact for snap-action switch | (1) $r=$ more than $10 \Omega$ <br> (2) In an AC circuit Impedance of $R$ is to be slightly smaller than impedance of $r$ and $c$. |
| Contact for snap-action switch | Can be used for both $A C$ and $D C$. Impedance of $r$ is nearly equal to impedance of $R$. <br> C: $0.1 \mu \mathrm{~F}$ |
| Contact for snap-action switch | (1) For DC circuits only. |
| Contact for snap-action switch | Can be used for both AC and DC. |

2) Do not connect the contacts on individual switches to different type or different poles of the power supply.
Examples of power supply connections (connection to different poles)


Example of wrong power supply connection (connection to different poles of power supply)
This may lead to mixed DC and AC.

3) Avoid circuits which apply voltage between contacts. (This may lead to mixed deposition.)

Wrong


## MOUNTING STATE AND ENVIRONMENT

## $\square$ Checking the insulation distance

After mounting and wiring, check the insulation distance between terminals and the ground. If the insulation distance is inadequate mount insulating material between as required.

Fastening the snap-action switch body
See the Section "CAUTIONS FOR USE" for the individual switch.

■ Position adjustment with effector

1) The effector should be positioned so that direct force is not applied to the plunger or actuator in its free position. The operating force to the plunger should only be applied in a perpendicular direction.
2) Note that the use of the switch as a stopper may cause an operational problem.

## —Switch installation position

Basically, the switch should be installed so that the object to press the switch's plunger or lever can press it down to 70 to $100 \%$ of OT of the switch. When determining the position, the tolerance of OP (Operating Position) and other factors should be taken into account. The following describes the case where the strictest tolerance conditions are adopted.
Example: Hinge lever type FS switch Reference values: OP $=8.8 \pm 0.8 \mathrm{~mm}$

$$
\mathrm{PT}=\mathrm{Max} .2 .8 \mathrm{~mm}
$$

$$
\mathrm{OT}=\mathrm{Min} .1 .2 \mathrm{~mm}
$$


(1) When the switch is not pressed

The object to press the lever should not be in contact with the lever.
For this purpose, the object should be at a distance from the switch father than the maximum FP (Free Position) value. FP Max = OP Max + PT Max = $9.6+2.8=12.4 \mathrm{~mm}$ Max The object should be at a distance of 12.4 mm or more from the mounting hole.
(2) Depressed position

The plunger/lever should be pressed down to $70 \%$ or more of OT (Over Travel). Therefore, the depressed position should be calculated based on the minimum value of OP (Operating Position) and the 70 and $100 \%$ of the OT value.
OP Min-70\% of OT = 8.0-0.84 = 7.16 mm
OP Min $-100 \%$ of $\mathrm{OT}=8.0-1.2=6.80 \mathrm{~mm}$
The plunger/lever should be pressed down to the position of 6.80 to 7.16 mm from the mounting hole.

## Soldering precautions

For manual soldering, lay the terminals flat (horizontal with the ground) and quickly perform the soldering operation using a soldering iron with the appropriate heat capacity and the proper amount of solder. Take care that the flux does not flow into the switch interior by using a ventilation fan to discharge flux gas and to prevent contact of the switch body with the soldering iron tip. Be careful not to apply force to the lead wires or the terminal portions immediately after soldering.
The temperature setting and time conditions vary depending on the product.
See the section "CAUTIONS FOR USE" for each product.

## <Examples>



## Avoid using in a silicon atmosphere

Avoid using organic silicon rubber, adhesives, sealing compounds, oil, grease, and wires in a silicon atmosphere.

Please consult us when using under the following conditions*:

1) Environments where hydrogen sulfide or other corrosive gases are present.
2) Environments where gasoline, thinner or other flammable, explosive gases are present.
3) Dusty environments (for non-seal type snap action switches).
4) The perpendicular operating speed exceeds the allowable operating speed.
5) Switching between different poles.
6) Use in environments not in the prescribed temperature or humidity range.

## Storage precautions

To prevent discoloration due to sulfurization of the terminals (silverplated), store the switches in a polyethylene bag or other suitable airtight container.
$\square$ Usage, storage, and transport conditions (except turquoise switches)
During usage, storage, or transportation, avoid locations subject to direct sunlight and maintain normal temperature, humidity, and pressure conditions.
The allowable specifications for environments suitable for usage, storage, and transportation are given below.

1) Temperature: The allowable temperature range differs for each switch, so refer to the switch's individual specifications. In addition, when transporting or storing switches while they are tube packaged, there are cases when the temperature may differ from the allowable range. In this situation, be sure to consult the individual specifications.
2) Humidity: The allowable temperature range differs for each switch, so refer to the switch's individual specifications.
3) Pressure: 86 to 106 kPa

The humidity range varies with the temperature. Use within the range indicated in the graph below.

(The allowable temperature depends on the switch.)

- Condensation will occur inside the switch if there is a sudden change in ambient temperature when used in an atmosphere of high temperature and high humidity. This is particularly likely to happen when being transported by ship, so please be careful of the atmosphere when shipping. Condensation is the phenomenon whereby steam condenses to cause water droplets that adhere to the switch when an atmosphere of high temperature and humidity rapidly changes from a high to low temperature or when the switch is quickly moved from a low humidity location to one of high temperature and humidity.
Please be careful because condensation can cause adverse conditions such as deterioration of insulation, coil cutoff, and rust.
- Condensation or other moisture may freeze on the switch when the temperatures is lower than $0^{\circ} \mathrm{C} 32^{\circ} \mathrm{F}$. This causes problems such as sticking of movable parts or operational time lags.
- The plastic becomes brittle if the switch is exposed to a low temperature, low humidity environment for long periods of time.
Storage for extended periods of time (including transportation periods) at high temperatures or high humidity levels or in atmospheres with organic gases or sulfide gases may cause a sulfide film or oxide film to form on the surfaces of the contacts and/ or it may interfere with the functions. Check out the atmosphere in which the units are to be stored and transported.
- In terms of the packing format used, make every effort to keep the effects of moisture, organic gases and sulfide gases to the absolute minimum.

We reserve the right to modify without notice the materials, internal components, and other parts to improve product quality.

## Handling precautions

When handling the switches, be careful not to drop them on the floor since this may damage them.

* Select contact sulfurization (clipping) prevention products (FS and Au-clad double layer contacts) for use with extremely small loads or an environment-resistant Turquoise switch.


## Others

1) Failure modes of switches include short-circuiting, opencircuiting and temperature rises. If this switch is to be used in equipment where safety is a prime consideration, examine the possible effects of these failures on the equipment concerned, and ensure safety by providing protection circuits or protection devices. In terms of the systems involved, make provision for redundancy in the design and take steps to achieve safety design.
2) The ambient operating temperature (and humidity) range quoted is the range in which the switch can be operated on a continuous basis: it does not mean that using the switch within the rating guarantees the durability performance and environment withstanding performance of the switch. For details on the performance guarantee, check the specifications of each product concerned.

Technical Terminology \& Cautions for Use (Detection Switches)

| Shape | Classification | Pretravel <br> (PT) | Overtravel <br> (OT) | Operating <br> Force <br> (OF) | Vibration <br> Shock | Features |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

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